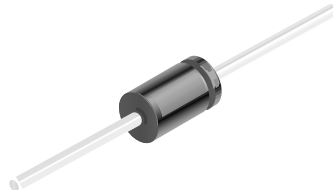


1N5282



DO-35

Color Band Denotes Cathode

Small Signal Diode

Absolute Maximum Ratings*

$T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Maximum Repetitive Reverse Voltage	80	V
$I_{F(AV)}$	Average Rectified Forward Current	200	mA
I_{FSM}	Non-repetitive Peak Forward Surge Current Pulse Width = 1.0 second Pulse Width = 1.0 microsecond	1.0 4.0	A A
T_{stg}	Storage Temperature Range	-65 to +200	$^\circ\text{C}$
T_J	Operating Junction Temperature	175	$^\circ\text{C}$

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

- 1) These ratings are based on a maximum junction temperature of 200 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

Symbol	Parameter	Value	Units
P_D	Power Dissipation	500	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	300	$^\circ\text{C}/\text{W}$

Electrical Characteristics

$T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
V_R	Breakdown Voltage	$I_R = 5 \mu\text{A}$	80		V
V_F	Forward Voltage	$I_F = 0.1 \text{ mA}$ $I_F = 1.0 \text{ mA}$ $I_F = 10 \text{ mA}$ $I_F = 100 \text{ mA}$ $I_F = 300 \text{ mA}$ $I_F = 500 \text{ mA}$	0.45 0.55 0.67 0.80 0.92 1.05	0.49 0.60 0.725 0.90 1.1 1.3	V V V V V V
I_R	Reverse Current	$V_R = 55 \text{ V}$ $V_R = 55 \text{ V}, T_A = 150^\circ\text{C}$		100 100	nA μA
C_T	Total Capacitance	$V_R = 0, f = 1.0 \text{ MHz}$		2.5	pF
t_{rr1}	Reverse Recovery Time	$I_F = I_R = 10 \text{ mA}, R_L = 100 \Omega$ $I_{rr} = 1.0 \text{ mA}$		4	ns
t_{rr2}	Reverse Recovery Time	$I_F = I_R = 200 \text{ mA}, R_L = 100 \Omega$ $I_{rr} = 20 \text{ mA}$		4	ns

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CoolFET™	FASTr™	MicroFET™	PowerTrench®	SuperSOT™-6
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EnSigna™	µC™	OCX™	RapidConfigure™	UHC™
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Programmable Active Droop™		OPTOPLANAR™	SMART START™	

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PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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